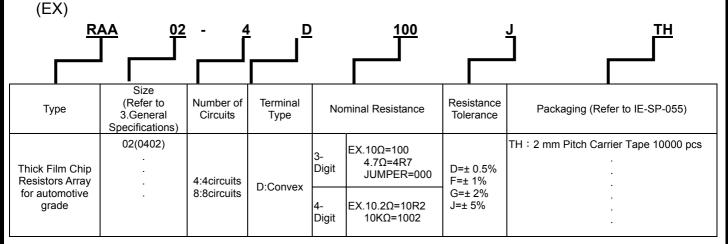
### RAA Thick Film Chip Resistors Array Automotive Grade Product Specification

Document No.	IE-SP-073
Released Date	2015/06/08
Page No	1/9

#### 1 Scope:

- 1.1 This specification is applicable to lead and halogen free RAA series thick film chip resistors array for automotive grade ∘
- 1.2 Lead free products mean lead free termination meets RoHS requirement. Pb contained in glass material of resistor element are exempted by RoHS directive •
- 1.3 Comply with AEC-Q200 standard

### 2 Explanation Of Part Numbers:



### 3 General Specifications:

•											
Туре	Rated Max. Power Workin		Max. Overload	load (nnm/°C)	Resistance Range		Number of	Number of	JUMPER (0Ω) Rated Current	JUMPER (0Ω) Resistance Value	
	at 70℃	Voltage	Voltage	(66 0)	D(±0.5%)	F(±1%)	G(±2%) \ J(±5%)	Terminals	Resistors	J	J
					E-24 \ E-96	E-24 \ E-96	E-24			(±5%)	(±5%)
RAA02-2D	1_\_\			±300		$1\Omega \le R < 10\Omega$	$1\Omega \le R < 10\Omega$				50mΩ
(0402) 16W	16 77	25V	50V	±200		$10\Omega {\le} R {\le} 10M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	4	2	1A	MAX.
RAA03-2D (0603)	1 16W	50V	100V	±200		10Ω≦R≦10MΩ	1Ω≦R≦10ΜΩ	4	2	1A	50mΩ MAX.
RAA02-4D	1 🕠	25V	50V	±300		$1\Omega \le R < 10\Omega$	$1\Omega \le R < 10\Omega$	8	4	1A	50mΩ
(0402)	16W	25V 50'	250 500	±200		$10\Omega \! \leq \! R \! \leq \! 10M\Omega$	$10\Omega {\le} R {\le} 10M\Omega$	0	4	1A	MAX.
RAA03-4D (0603)	1 16W	50V	100V	±200	22Ω≦R≦470KΩ	1Ω≦R≦10ΜΩ	1Ω≦R≦10MΩ	8	4	1A	50mΩ MAX.
RAA02-8D (0402)	1 16W	25V	50V	±250		10Ω≦R≦10MΩ	1Ω≦R≦10ΜΩ	16	8	1A	50mΩ MAX.
Operating Temperature Range					-55°C ~ +155°	C					

	ΙE		QA	Sales	Remark	Janua Dan DATA Cantan
Written	Checked	Approved	Signing	Signing	IT'S NOT UNDER CONTROL FOR PDF FILE	Issue Dep. <b>DATA Center.</b>
Written	一方	500/0	是沒是	鄭景縣	PLS NOTE THE VERSION STATED	
Jane Jane	1-0	201011	- V- V-	.,	Do not copy without permission	Series No. <b>60</b>

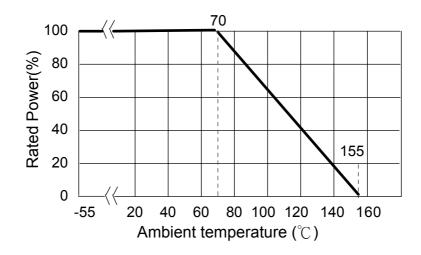
## RAA Thick Film Chip Resistors Array Automotive Grade Product Specification

Document No.	IE-SP-073
Released Date	2015/06/08
Page No	2/9

#### 3.1 Power Derating Curve:

Operating Temperature Range : - 55~155 °C

For resistors operated in ambient temperatures above 70  $^\circ\! C$  , power rating shall be derated in accordance with figure below  $^\circ$ 



#### 3.2 Voltage Rating:

Rated Voltage: The resistor shall have a DC continuous working voltage or a rms. AC continuous working voltage at commercial-line frequency and wave form corresponding to the power rating, as determined from the following:

$$E = \sqrt{R} \times P$$

E= Rated voltage (v) P= Power rating (w)

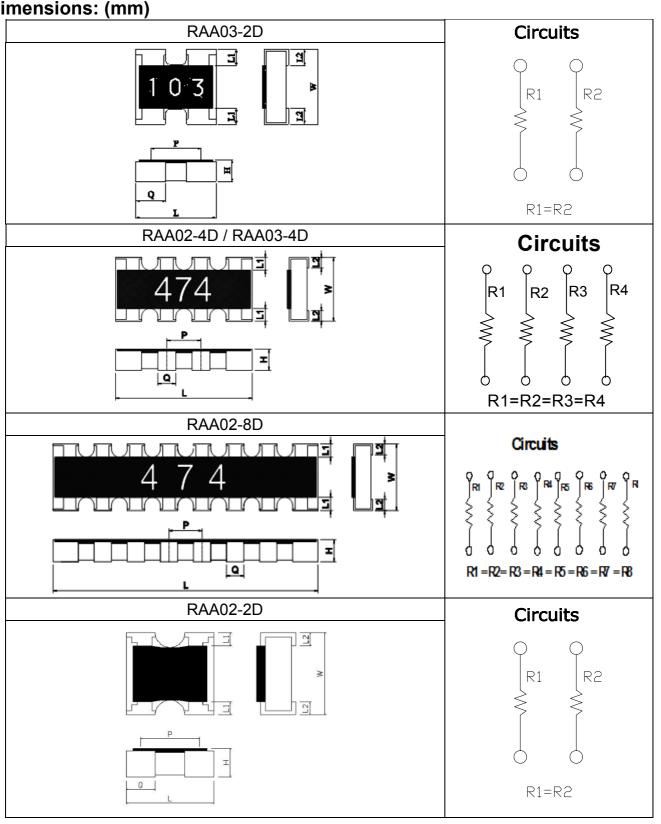
R= Nominal resistance( $\Omega$ )

Domonk	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. <b>DATA Center.</b>
Remark	Do not copy without permission	Series No. <b>60</b>

# **RAA Thick Film Chip Resistors Array Automotive Grade Product Specification**

IE-SP-073 Document No. 2015/06/08 Released Date Page No 3/9





Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. <b>DATA Center.</b>
Troman.	Do not copy without permission	Series No. <b>60</b>

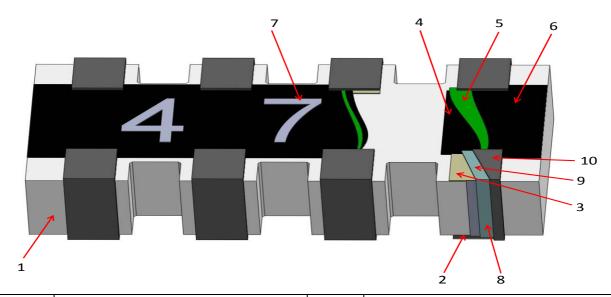
# RAA Thick Film Chip Resistors Array Automotive Grade Product Specification

Document No.	IE-SP-073
Released Date	2015/06/08
Page No	4/9

Unit:mm

TYPE DIM	L	W	н	L1	L2	Р	Q
RAA02-2D (0402)	1.00±0.10	1.00±0.10	0.30±0.05	0.15±0.10	0.25±0.10	(0.67)	0.33±0.10
RAA03-2D (0603)	1.60±0.15	1.60±0.15	0.45±0.10	0.30±0.15	0.30±0.15	(0.80)	0.60±0.10
RAA02-4D (0402)	2.00±0.10	1.00±0.10	0.40±0.10	0.20±0.10	0.25±0.10	(0.50)	0.30±0.10
RAA03-4D (0603)	3.20±0.20	1.60±0.15	0.50±0.10	0.30±0.15	0.30±0.15	(0.80)	0.50±0.10
RAA02-8D (0402)	4.00±0.20	1.60±0.10	0.40±0.10	0.30±0.15	0.30±0.10	(0.50)	0.25±0.10

# 5 Structure Graph:



1	Ceramic substrate	6	2nd Protective coating
2	Bottom inner electrode	7	Marking
3	Top inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. <b>DATA Center.</b>
Komark	Do not copy without permission	Series No. <b>60</b>

# RAA Thick Film Chip Resistors Array Automotive Grade Product Specification

Document No.	IE-SP-073
Released Date	2015/06/08
Page No	5/9

6 Reliability Test:

Item	Conditions	Specification	ons
пеш	Conditions	Resistors	Jumper
High Temperature Exposure (Storage)	Put the specimens in the chamber with temperature of 125±3°C for 1000 hours. Then take them out to stabilize in room temperature for 24±2hr or more, and measure of its resistance variance rate.  Experiment evidence: AEC-Q200	1. $0.5\% \times 1\%$ : $\Delta R = \pm (1.0\% + 0.05\Omega)$ 2. $2\% \times 5\%$ : $\Delta R = \pm (2.0\% + 0.10\Omega)$ No mechanical damage.	Refer to item 3. general specifications
Temperature Cycling	Put the specimens in the High & low temperature test chamber with temperature varies from -55°C to 155°C for 5 minutes and total 1000 cycles. Then take them out to stabilize in room temperature for 24±2hr or more, and measure of its resistance variance rate.  Experiment evidence: AEC-Q200	1. $0.5\% \times 1\%$ : $\Delta R = \pm (1.0\% + 0.05\Omega)$ 2. $2\% \times 5\%$ : $\Delta R = \pm (2.0\% + 0.05\Omega)$ No mechanical damage.	Refer to item 3. general specifications
Moisture Resistance	reference to the temperature \ humidity and duration specified in test method 7a, the specimens are put into the constant temperature humidity chamber to test for total 10 cycles (240hr) without load. Then take them out to stabilize in room temperature for 24±2hr or more, and measure of its resistance variance rate.  Experiment evidence: AEC-Q200	1. $0.5\% \cdot 1\%$ : $\Delta R = \pm (0.5\% + 0.05\Omega)$ 2. $2\% \cdot 5\%$ : $\Delta R = \pm (2.0\% + 0.05\Omega)$ No mechanical damage.	Refer to item 3. general specifications
	Solder the specimens on the test PCB and put them into the constant temperature humidity chamber with 85±2°C and 85±5%RH. Then apply the test voltage that calculates based on the 10% of rated power for 1000hrs. Then take them out to stabilize in room temperature for 24±2hr or more, and measure of its resistance variance rate. Experiment evidence: AEC-Q200	1. 0.5% \ 1% : Δ R=±(0.5%+0.05Ω) 2. 2% \ 5% : ΔR=±(2.0%+0.10Ω) No mechanical damage, burning out phenomenor	
Operational Life	Solder the specimens on the test PCB and Put them in the chamber with temperature of 125±3°C and load the rated voltage for 1000 hours. Then take them out to stabilize in room temperature for 24±2hr or more, and measure of its resistance variance rate.  Experiment evidence: AEC-Q200	1. 0.5% \ 1% :	
Physical Dimension	Measure of chip size (L \ W \ H) by size measuring tool.  Measure of conductor size with the high-power microscope  Experiment evidence: AEC-Q200	Refer to Datasheet iter	
Resistance to Solvents	Take the specimens to be immersed into the isopropyl alcohol of 25±5°C for 3+0.5/-0 minutes, then rinse with water and stabilize for 48 hrs or more, and measure of its resistance variance rate.  Experiment evidence: AEC-Q200	△R=±(0.5%+0.05Ω)  No mechanical damage, overcoat & marking or Leproblem.	
Resistance to Soldering Heat	The specimens are fully immersed into the Pb-free solder pot, then take them out to stabilize for 1 hour or more and measure of its resistance variance rate.  Temp of solder pot : 260±5°C  Soldering duration : 10±1sec.  Experiment evidence AEC-Q200	$\Delta$ R%=±(1.0%+0.05Ω  No cosmetic defect on tepeeling off of side end.	Refer to item 3. general specifications rminal or

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. <b>DATA Center.</b>
Kemark	Do not copy without permission	Series No. <b>60</b>

# RAA Thick Film Chip Resistors Array Automotive Grade Product Specification

 Document No.
 IE-SP-073

 Released Date
 2015/06/08

 Page No
 6/9

Itom	Conditions	Specification	ons
Item	Conditions	Resistors	Jumper
Thermal Shock	Solder the specimens on the test PCB and put them into the Thermal Shock Test Chamber with the temperature of -55°C for 15min and +125°C for 15min, which is specified as 1 cycle and total 300 cycles needed. Then take out the specimens to stabilize for 24±2hr or more and measured of its resistance variance rate.  Test condition The lowest Temp		Refer to item 3. general specifications
Put the specimens on the test fixture and two discharges (2KV DC) shall be applied to each PUT, one with a positive polarity and one with a negative polarity. Afterwards, the specimens stabilize for 30min or more and measure of its resistance variance rate. The test is performed with direct		1. $0.5\% \times 1\%$ : $\triangle R = \pm (2.0\% + 0.05\Omega)$ 2. $2\% \times 5\%$ : $\triangle R = \pm (3.0\% + 0.10\Omega)$ No mechanical damage, burning out phenomenor	
Solderability	Put the specimens in the apparatus of PCT, at a temperature of 105°C, humidity of 100% RH, and air pressure of 1.22× 105 Pa for a duration of 8 hours. Then leave the specimens in room temperature for 2 hours. Test method:  Test item 1 (solder pot test): Method A  The specimens are immersed into the flux first, then fully immersed into the solder pot, at a temperature of 235± 5°C for 5+0/-0.5 sec. Then rinse with water and observe the soldering coverage under the microscope.  Test item 2 (Leaching test): Method D  The specimens are immersed into the flux first, then fully immersed into the solder pot, at a temperature of 260±5°C for 120±5sec. Then rinse with water and observe the soldering coverage under the microscope.  Experiment evidence AEC-Q200	1.Soldering coverage ov 2.At the edge of termina underneath (e.g. white cont expose.	I, the object
Electrical Characterization	TCR (ppm / $^{\circ}$ C) = $\frac{(R2-R1)}{R1(T2-T1)} \times 10^6$ R1: Resistance at room temperature ( $\Omega$ ) R2: Resistance at -55 $^{\circ}$ C or +125 $^{\circ}$ C( $\Omega$ ) T1: Room temperature ( $^{\circ}$ C) T2: Temperature -55 $^{\circ}$ C or +125 $^{\circ}$ C Experiment evidence: AEC-Q200	Refer to item 3. general specifications	NA
Board Flex (Bending Test)	Solder the specimens on the test PCB and put the PCBA onto the Bending Tester. Add force at the central part of PCB, and measure of its resistance variance rate in load. Bending depth (D)=5mm Experiment evidence: AEC-Q200	$\Delta R = \pm (1.0\% + 0.05\Omega)$ No mechanical damage, side end or chip crack.	Refer to item 3 general specifications peeling off of

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. <b>DATA Center.</b>
Remark	Do not copy without permission	Series No. <b>60</b>

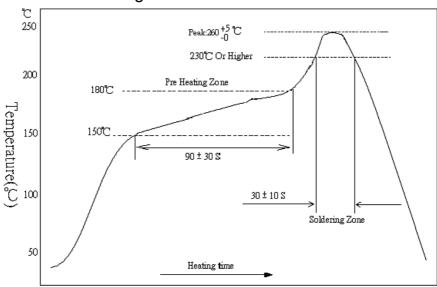
# RAA Thick Film Chip Resistors Array Automotive Grade Product Specification

Document No.	IE-SP-073
Released Date	2015/06/08
Page No	7/9

Item	Conditions	Specifications		
пеш	Conditions	Resistors	Jumper	
Terminal Strength (SMD)	ialiu liicasule ul lesisialice valialice late III luau.	$\Delta R = \pm (1.0\% + 0.05\Omega)$ No mechanical damage side end.	Refer to item 3. general specifications or peeling off of	
Sulfuration Test	at the contract of the contrac	ΔR=±(1.0%+0.05Ω)	Refer to item 3. general specifications	

### 7 Recommend Soldering Method:

7.1 Lead Free IR-Reflow Soldering Profile



Remark: The peak temperature of soldering heat is 260 +5/-0 °C for 10 seconds

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. <b>DATA Center.</b>
Remark	Do not copy without permission	Series No. <b>60</b>

# RAA Thick Film Chip Resistors Array Automotive Grade Product Specification

Document No.	IE-SP-073
Released Date	2015/06/08
Page No	8/9

### 8 Recommend Land Pattern Design (For Reflow Soldering):

Unit:mm

RTA02-2D/RTA03-2D	RTA02-4D / RTA03-4D	RTA02-8D
Q1   Q2	P	P-1

TYPE DIM	Α	В	Р	Q1	Q2
RAA02-2D	0.50	2.00	0.67	0.33	0.34
RAA03-2D	1.00	2.60	0.80	0.40	0.40
RAA02-4D	0.50	2.00	0.50	0.28	0.22
RAA03-4D	1.00	2.60	0.80	0.40	0.40
RAA02-8D	1.00	2.60	0.50	0.25	0.25

### 9 Plating Thickness:

9.1 Ni: $\ge$ 2  $\mu$  m

9.2 Sn(Tin):  $\geq$ 3  $\mu$  m

9.3 Sn(Tin): Matte Sn

### 10 Rule of package empty quantity:

10.1 Each reel that empty quantities don't exceed 0.1% of whole quantities and continuous 2pcs (included) are allowed

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. <b>DATA Center.</b>
	Do not copy without permission	Series No. <b>60</b>

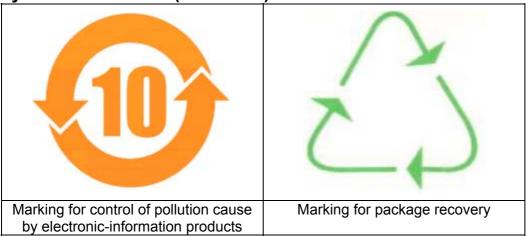
# RAA Thick Film Chip Resistors Array Automotive Grade Product Specification

Document No.	IE-SP-073
Released Date	2015/06/08
Page No	9/9

### 11 Stock period:

11.1 The temperature condition must be controlled at 25±5°C, the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years.

12 The carton packaged for electronic-information products is made by the symbol as follows: (For china)



#### 13 Attachments:

13.1 Document Revise Record Paper (QA-QR-027)

Remark	IT'S NOT UNDER CONTROL FOR PDF FILE PLS NOTE THE VERSION STATED	Issue Dep. <b>DATA Center.</b>
	Do not copy without permission	Series No. <b>60</b>